Qualcomm

RF360
Europe GmbH

Data sheet

SAW filter
GPS

Series/type:	B4300
Ordering code:	B39162B4300F210
Date:	July 12, 2019
Version:	2.3

DCN: 80-PA243-356 Rev. A

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RF360 Europe GmbH
A Qualcomm – TDK Joint Venture

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1 Application

- Low-loss RF filter for GPS application
- No matching network required for operation at 50 Ω

2 Features

- Package size $1.4_{\pm 0.1}$ mm × $1.1_{\pm 0.1}$ mm
- Package height 0.45 mm (max.)
- Approximate weight 3 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)
- AEC-Q200 qualified component family (Grade 3: −40 °C to +85 °C)

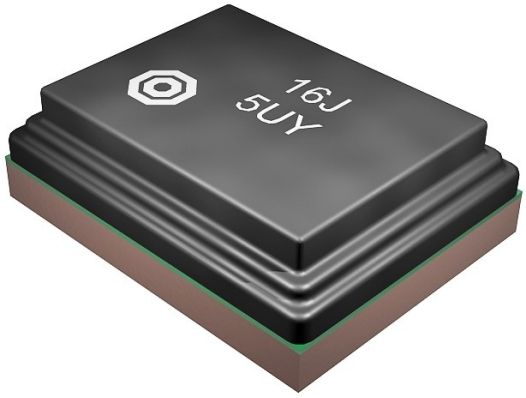

Figure 1: Picture of component with example of product marking.

3 Package

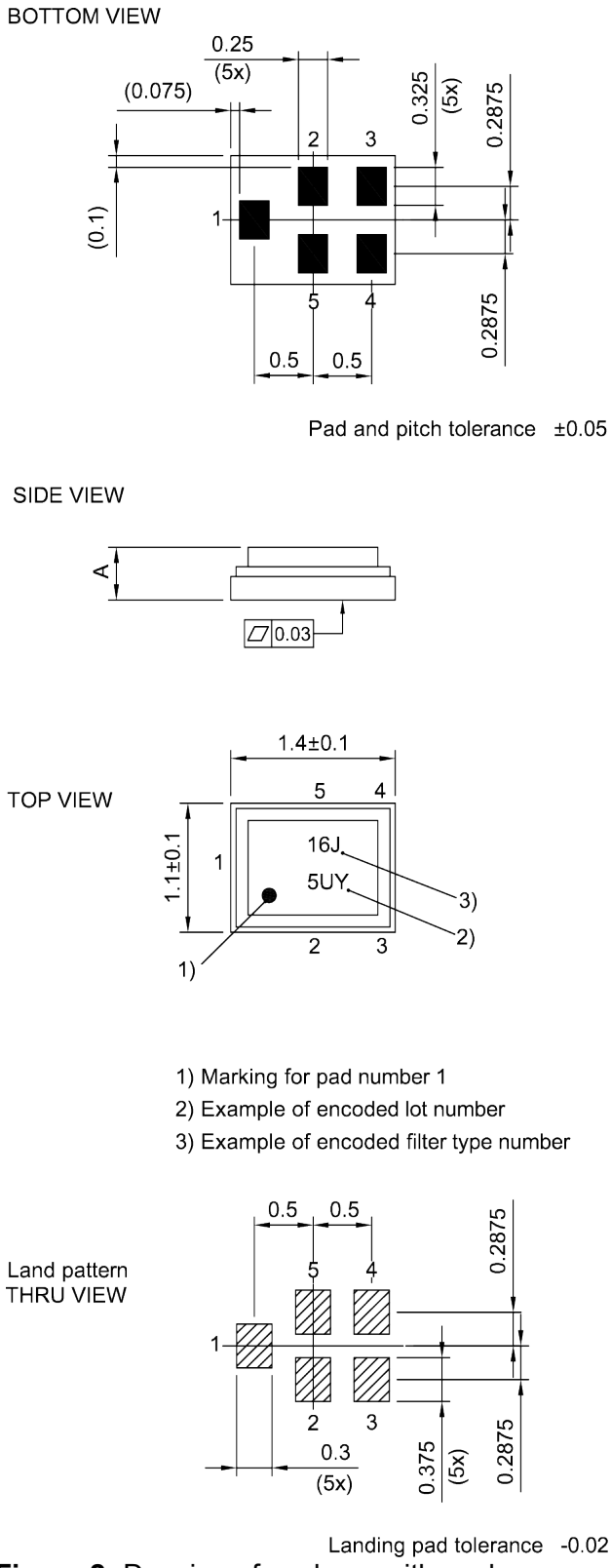

Figure 2: Drawing of package with package height A = 0.45 mm (max.). See Sec. Package information (p. 16).

4 Pin configuration

- 1 Input
- 4 Output
- 2, 3, 5 Ground

5 Matching circuit

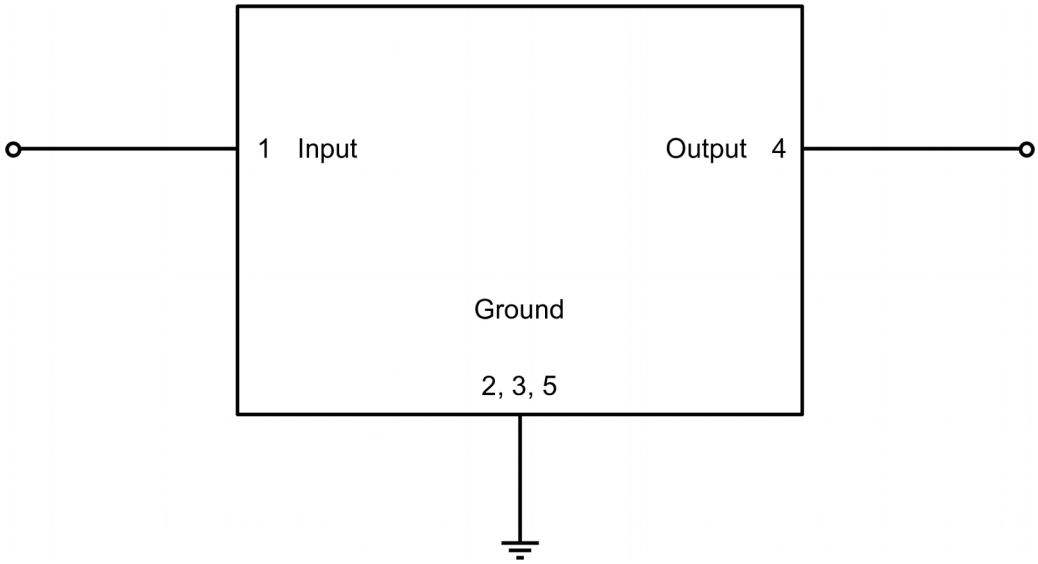

Figure 3: Schematic of matching circuit. No external matching components required.

6 Characteristics

Temperature range for specification T_{SPEC} = −40 °C ... +85 °C
Input terminating impedance Z_{IN} = 50 Ω
Output terminating impedance Z_{OUT} = 50 Ω

Characteristics				min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Center frequency			f_C	—	1575.42	—	MHz
Maximum insertion attenuation			α_{max}				
	1572.42... 1578.42	MHz		—	1.2	1.8	dB
	1573.92... 1576.92	MHz		—	1.0	1.3	dB
Amplitude ripple (p-p)			$\Delta\alpha$				
	1572.42... 1578.42	MHz		—	0.4	1.0	dB
	1573.92... 1576.92	MHz		—	0.1	0.6	dB
Maximum VSWR			$VSWR_{max}$				
@ input port	1572.42... 1578.42	MHz		—	1.5	1.9	
	1573.92... 1576.92	MHz		—	1.3	1.7	
@ output port	1572.42... 1578.42	MHz		—	1.5	1.9	
	1573.92... 1576.92	MHz		—	1.3	1.7	
Minimum attenuation			α_{min}				
	1.0... 810	MHz		41	45	—	dB
	810... 1453	MHz		40	45	—	dB
	1453... 1525	MHz		37	44	—	dB
	1625... 1710	MHz		40	50	—	dB
	1710... 1749	MHz		43	50	—	dB
	1749... 1785	MHz		44	50	—	dB
	1785... 1920	MHz		43	50	—	dB
	1920... 2200	MHz		41	52	—	dB
	2200... 2450	MHz		35	40	—	dB
	2450... 2700	MHz		40	50	—	dB
	2700... 4000	MHz		30	35	—	dB

7 Maximum ratings

Operable temperature	T_{OP} = −40 °C ... +85 °C	
Storage temperature	T_{STG} [1] = −40 °C ... +85 °C	
DC voltage	$\|V_{DC}\|$ [2] = 0 V (max.)	
Source power	P_S	
	10 dBm	Source impedance 50 Ω.
824 ... 915 MHz	20 dBm	
1710 ... 1785 MHz	20 dBm	

[1] Not valid for packaging material. Storage temperature for packaging material is −25 °C to +40 °C.
[2] In case of applied DC voltage blocking capacitors are mandatory.

8 Transmission coefficient

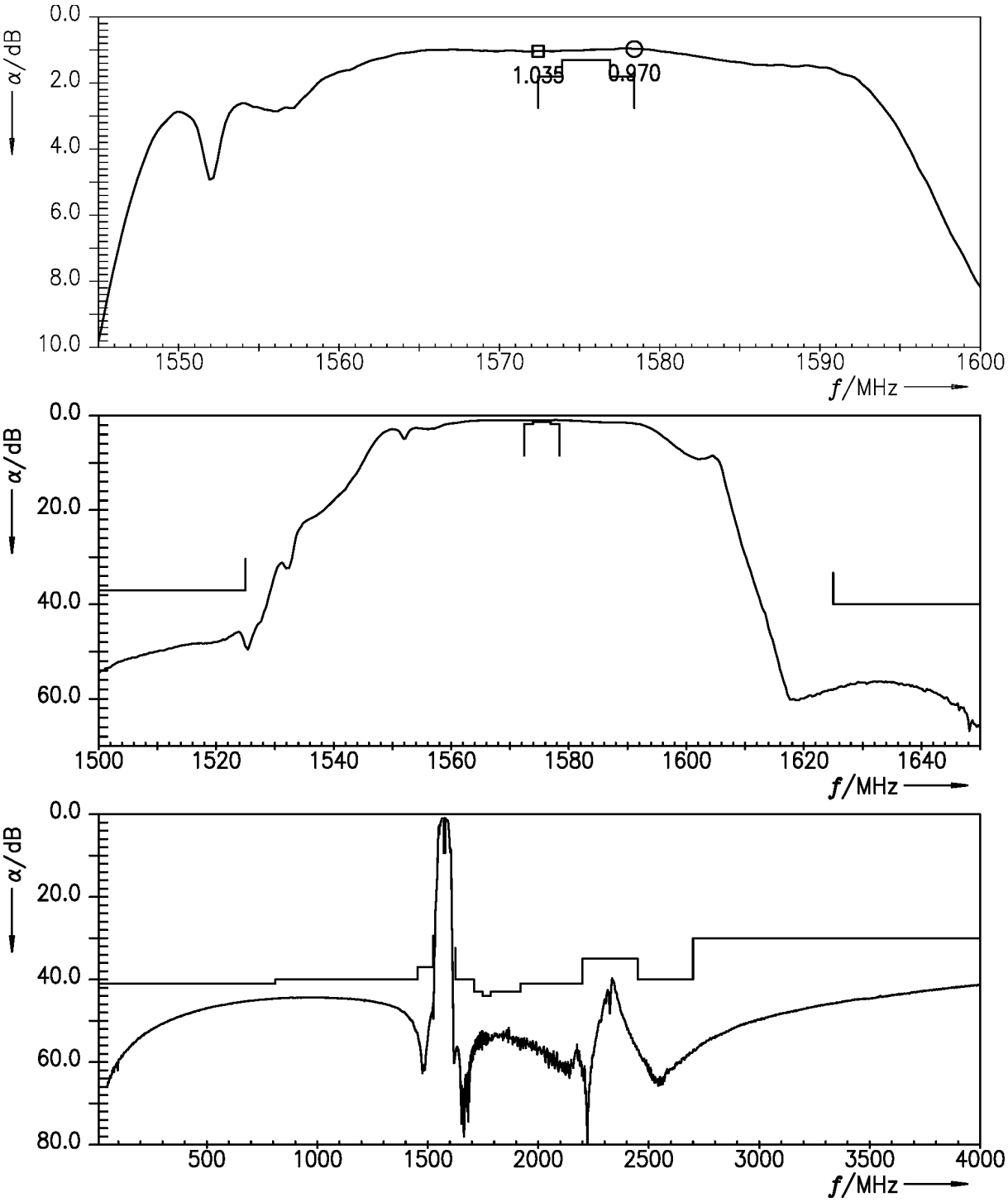

Figure 4: Attenuation.

9 Packing material

9.1 Tape

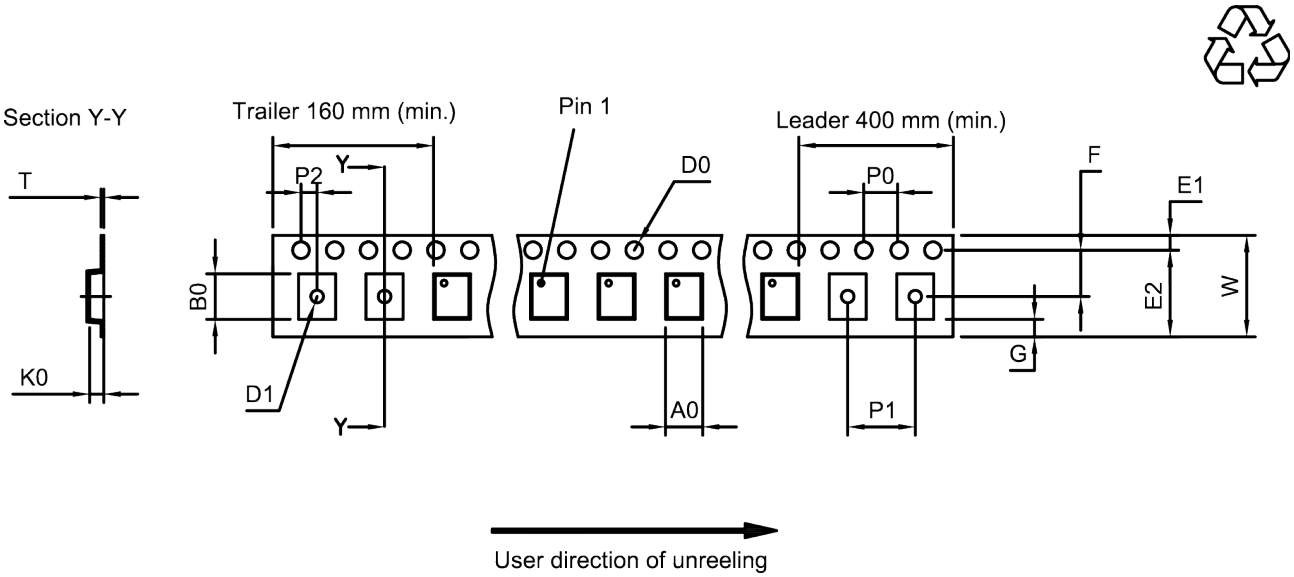

Figure 5: Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

A_0	1.27±0.05 mm
B_0	1.57±0.05 mm
D_0	1.5+0.1/−0 mm
D_1	0.5±0.1 mm
E_1	1.75±0.1 mm

E_2	6.25 mm (min.)
F	3.5±0.05 mm
G	0.75 mm (min.)
K_0	0.62±0.05 mm
P_0	4.0±0.1 mm

P_1	4.0±0.1 mm
P_2	2.0±0.05 mm
T	0.25±0.03 mm
W	8.0+0.3/−0.1 mm

Table 1: Tape dimensions.

9.2 Reel with diameter of 180 mm

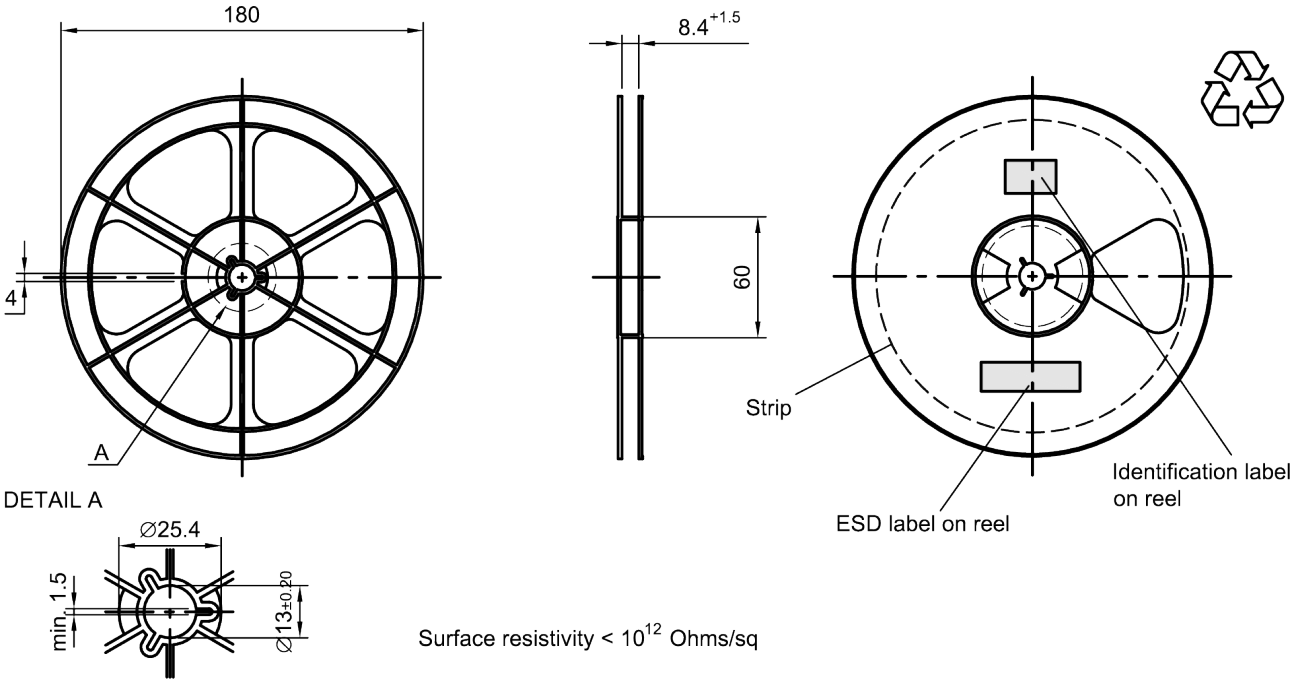

Figure 6: Drawing of reel (first-angle projection) with diameter of 180 mm.

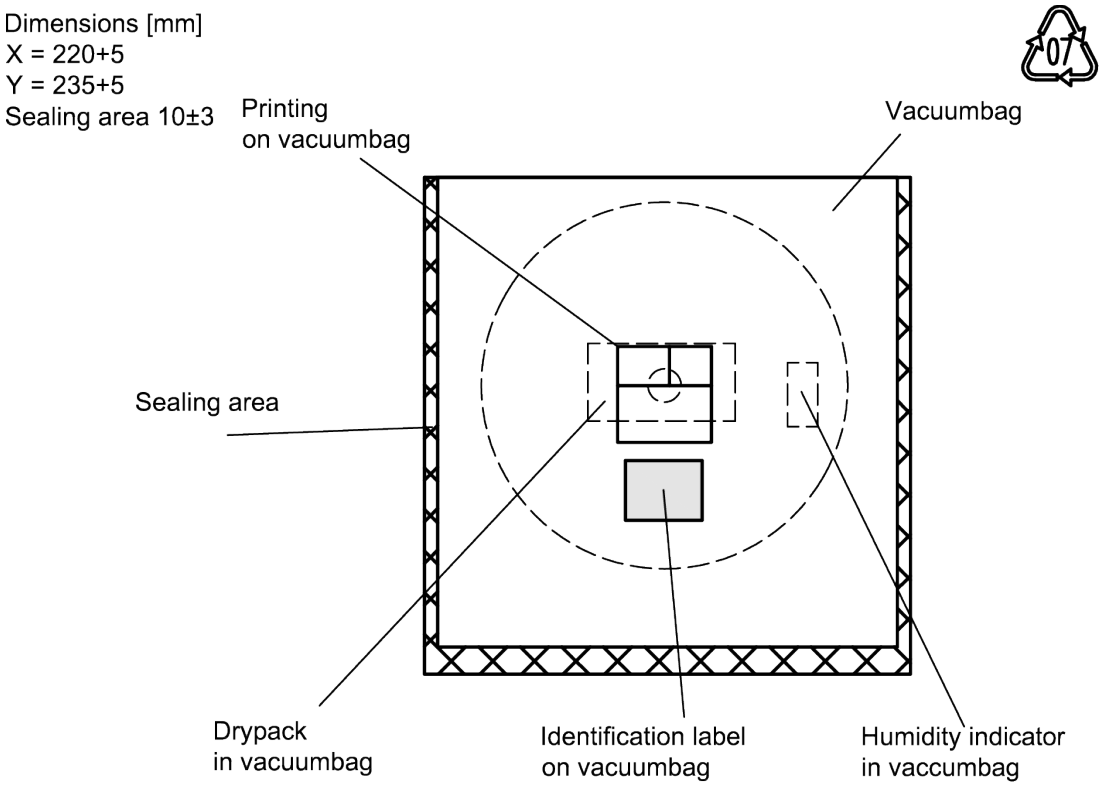

Figure 7: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

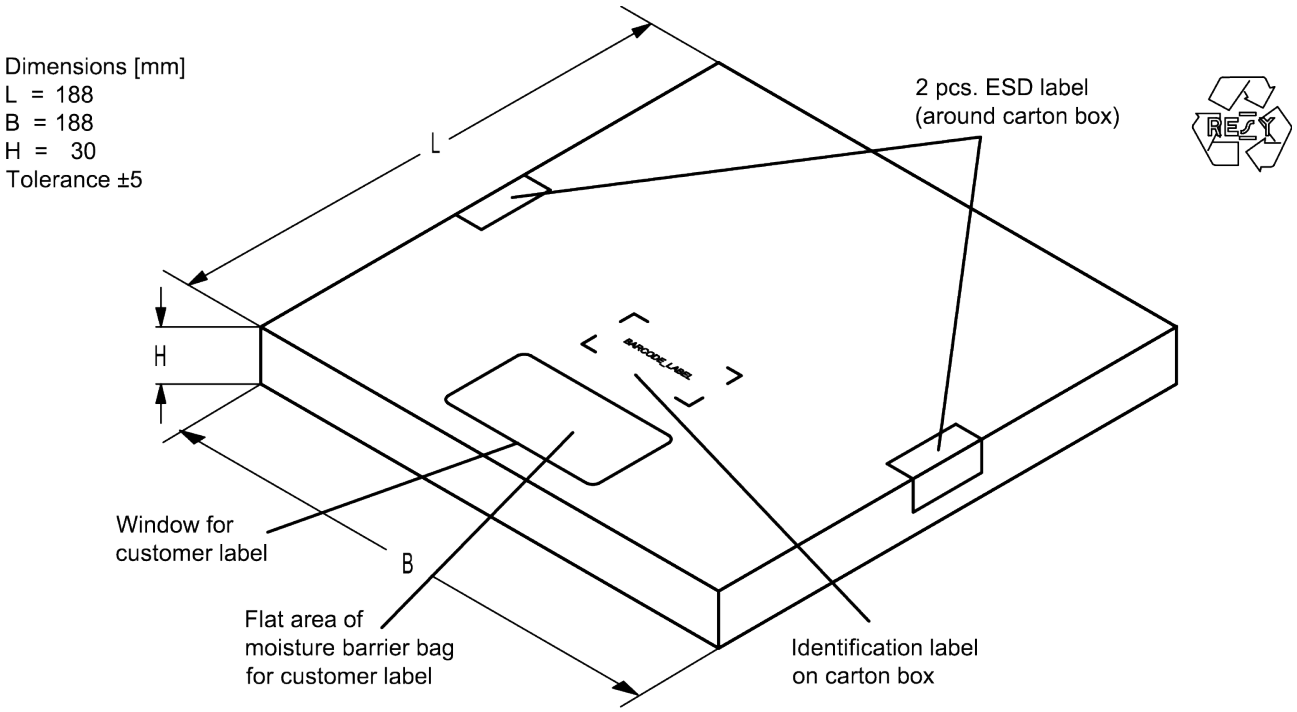

Figure 8: Drawing of folding box for reel with diameter of 180 mm.

10 Marking

Products are marked with product type number and lot number encoded according to Table 2:

- Type number:

  The 4 digit type number of the ordering code, e.g., B3xxxxB**1234**xxxx,
  is encoded by a special BASE32 code into a 3 digit marking.

  Example of decoding type number marking on device in decimal code.

  16J **=>** **1234**

  1 x 32^2 + **6** x 32^1 + **18 (=J)** x 32^0 **=** **1234**

  The BASE32 code for product type B4300 is 46C.

- Lot number:

  The last 5 digits of the lot number, e.g., **12345**,
  are encoded based on a special BASE47 code into a 3 digit marking.

  Example of decoding lot number marking on device in decimal code.

  5UY **=>** **12345**

  5 x 47^2 + **27 (=U)** x 47^1 + **31 (=Y)** x 47^0 **=** **12345**

Adopted BASE32 code for type number			
Decimal value	Base32 code	Decimal value	Base32 code
0	0	16	G
1	1	17	H
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	P
7	7	23	Q
8	8	24	R
9	9	25	S
10	A	26	T
11	B	27	V
12	C	28	W
13	D	29	X
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	T
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	B	35	f
12	C	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	H	41	\
18	J	42	?
19	K	43	{
20	L	44	}
21	M	45	<
22	N	46	>
23	P		

Table 2: Lists for encoding and decoding of marking.

11 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
T ≥ 255 °C	–
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

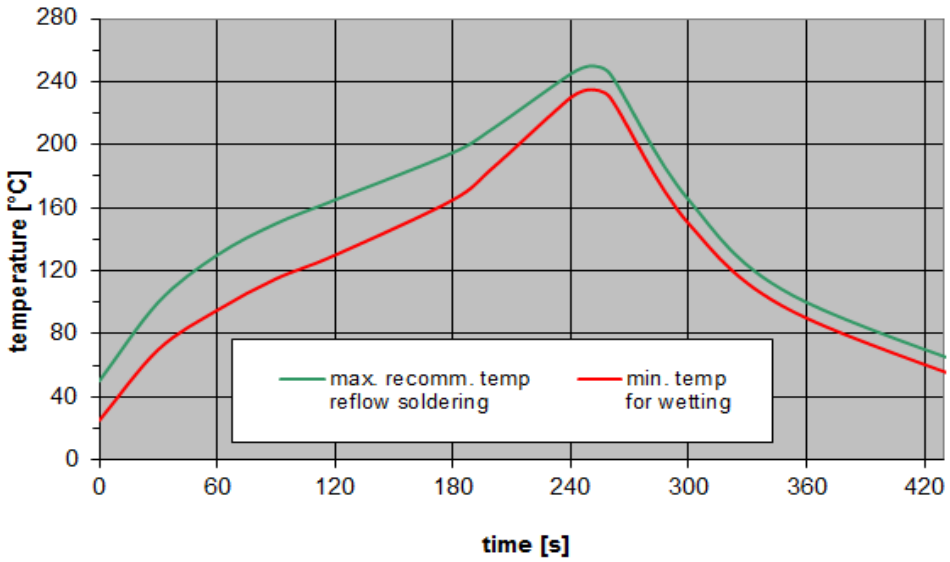

Figure 9: Recommended reflow profile for convection and infrared soldering – lead-free solder.

12 Annotations

12.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

12.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

13 Cautions and warnings

13.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

13.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

13.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

13.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.

14 Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application.** As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
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3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.rf360jv.com/material). Should you have any more detailed questions, please contact our sales offices.
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